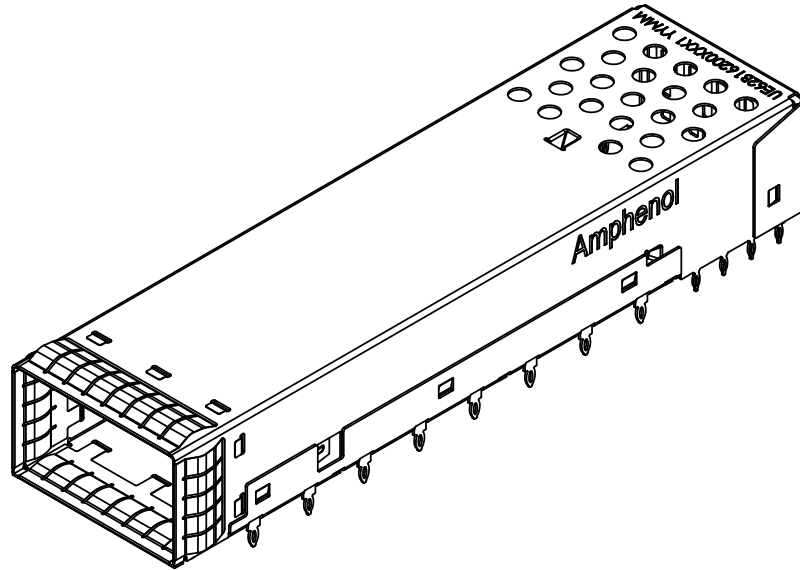


REVISIONS				
REV.	ECN	DESCRIPTION	DATE	APPROVED
A		PROPOSAL	JUL 04,19	J.SI
B		UPDATE THE NOTES ON PAGE4	JUL 31,19	J.SI
C		UPDATE THE PCB DIMENSION	AUG 20,19	J.SI



NOTES:

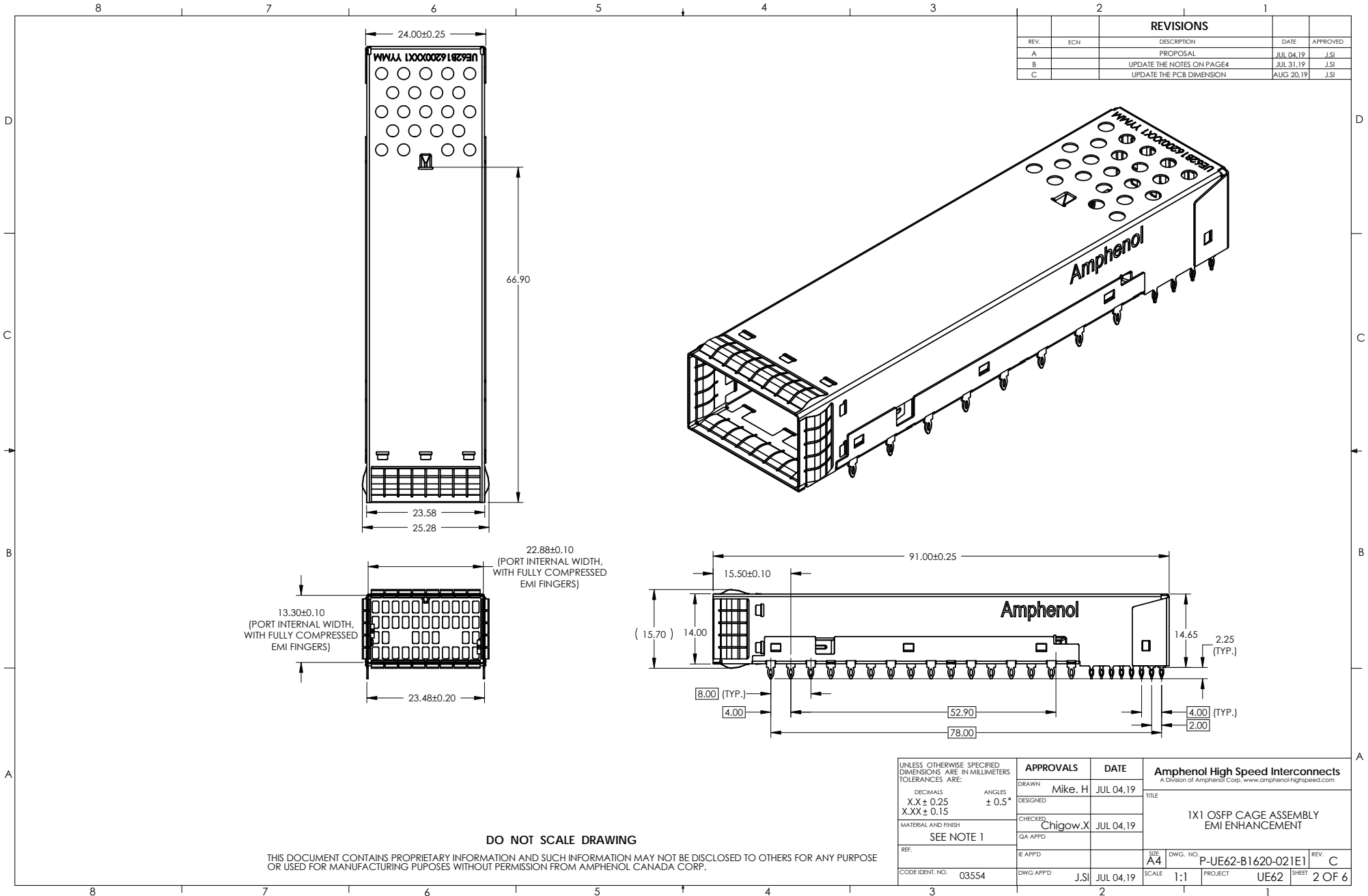
- 1) MATERIAL: COPPER ALLOY.
- 2) PLATING: 2.54 μm MIN.NICKEL.
- 3) PACKAGING: TRAY PACKAGING.
- 4) COMPLIES WITH OSFP MSA .
- 5) AMPHENOL PART NUMBER:
UE62-B1620-021E1



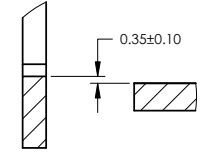
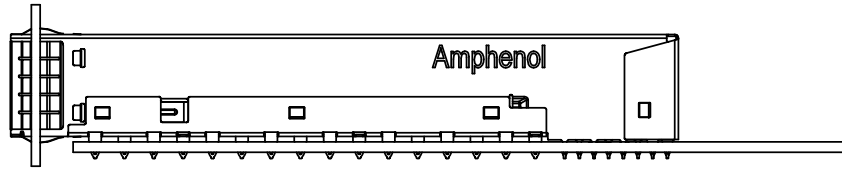
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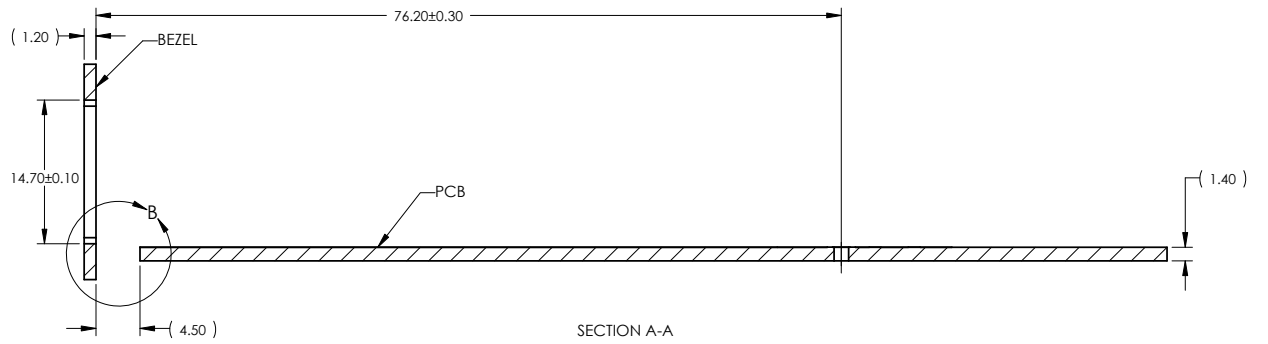
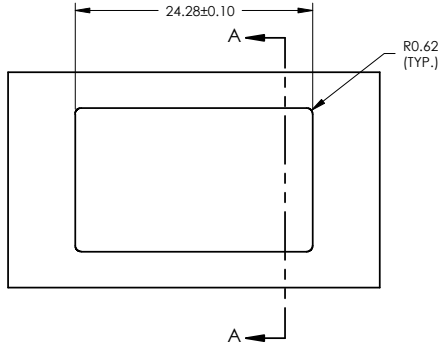
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS TOLERANCES ARE:		APPROVALS	DATE	Amphenol High Speed Interconnects <small>A Division of Amphenol Corp. www.amphenol-highspeed.com</small>	
DECIMALS X.X ± 0.25 X.XX ± 0.15	ANGLES ± 0.5°	DRAWN Mike. H	JUL 04,19	TITLE 1X1 OSFP CAGE ASSEMBLY EMI ENHANCEMENT	
MATERIAL AND FINISH SEE NOTE 1		CHECKED Chigow.X	JUL 04,19	SIZE A4	DWG. NO. P-UE62-B1620-021E1
REF.	E APPD	QA APPD		SCALE 1:1	REV. C
CODE IDENT. NO. 03554	DWG APPD J.SI	JUL 04,19		PROJECT UE62	SHEET 1 OF 6



REVISIONS				
REV.	ECN	DESCRIPTION	DATE	APPROVED
A		PROPOSAL	JUL 04,19	J.SI
B		UPDATE THE NOTES ON PAGE4	JUL 31,19	J.SI
C		UPDATE THE PCB DIMENSION	AUG 20,19	J.SI

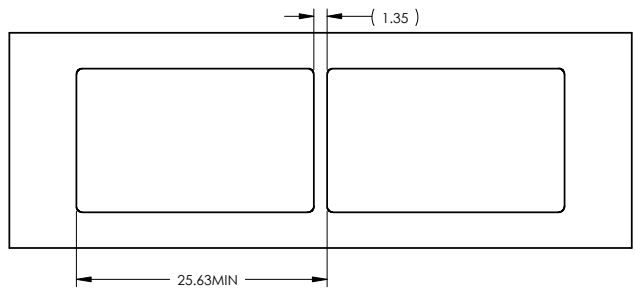


DETAIL B
SCALE 4 : 1



SECTION A-A
SCALE 2 : 1

RECOMMENDED BEZE DESIGN
FOR SINGLE SAID MOUNTING



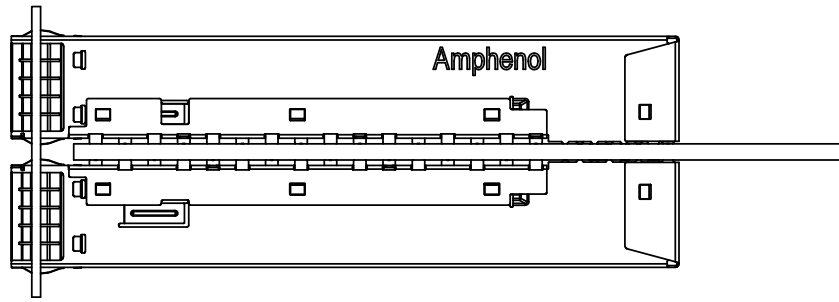
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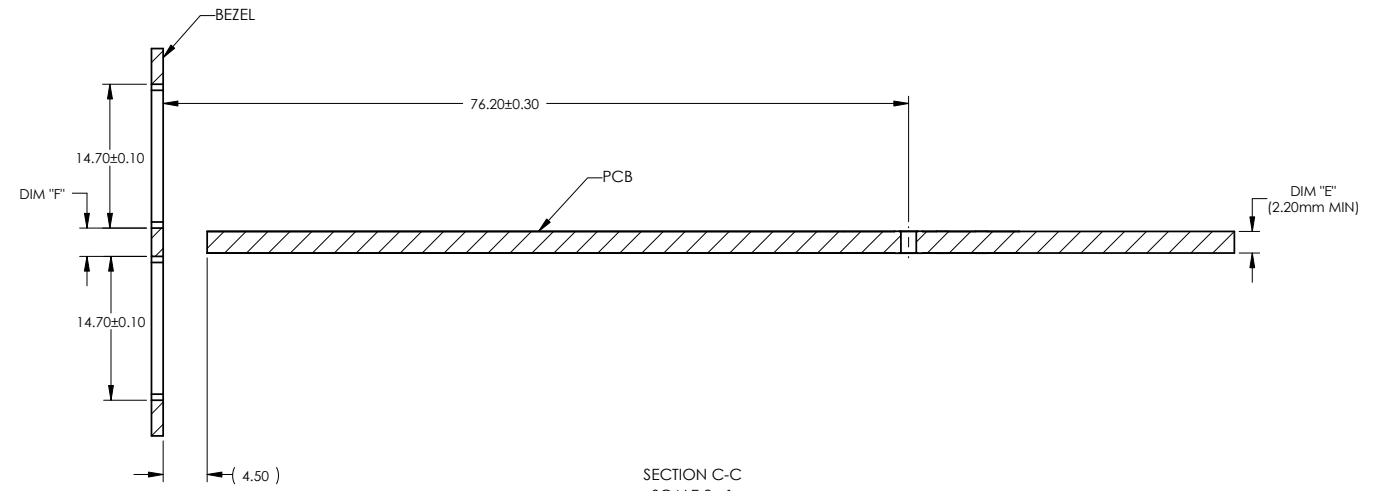
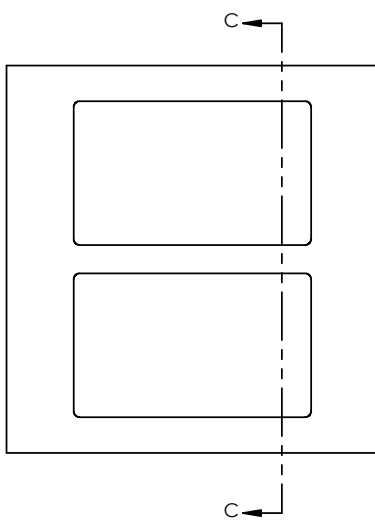
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS TOLERANCES ARE:		APPROVALS		DATE		Amphenol High Speed Interconnects A Division of Amphenol Corp. www.amphenol-highspeed.com			
DECIMALS X.X ± 0.25 X.XX ± 0.15		ANGLES ± 0.5°		DRAWN Mike. H		JUL 04,19		TITLE	
MATERIAL AND FINISH		CHECKED Chigow.X		DESIGNED		JUL 04,19		1X1 OSFP CAGE ASSEMBLY EMI ENHANCEMENT	
SEE NOTE 1		QA APPD		E APPD		SCALE		SIZE DWG. NO. PROJECT SHEET	
REF.		DWG APPD J.SI		JUL 04,19		1:1		P-UE62-B1620-021E1 C	
CODE IDENT. NO. 03554		J.SI		JUL 04,19		1:1		UE62 3 OF 6	

8 7 6 5 4 3 2 1

REVISIONS				
REV.	ECN	DESCRIPTION	DATE	APPROVED
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NOTE:
 PANEL CUTOUT SIZES PER OSFP MSA SPEC. FOR BELLY TO BELLY MOUNTING, DIM "E" (PCB THICKNESS) IS 2.20 mm MIN. DIM "F" RELATED TO DIM "E". FOR DIM "F" = DIM "E" + 0.70 mm. THE PANEL CUTOUT 14.70 mm MIGHT BE INCREASED UP TO 15.10 mm IN ORDER TO ACCOMMODATE PCB TOLERANCE.



SECTION C-C
 SCALE 2 : 1

RECOMMENDED BEZE DESIGN
 (BELLY TO BELLY CAGE MOUNTING)

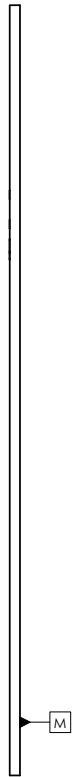
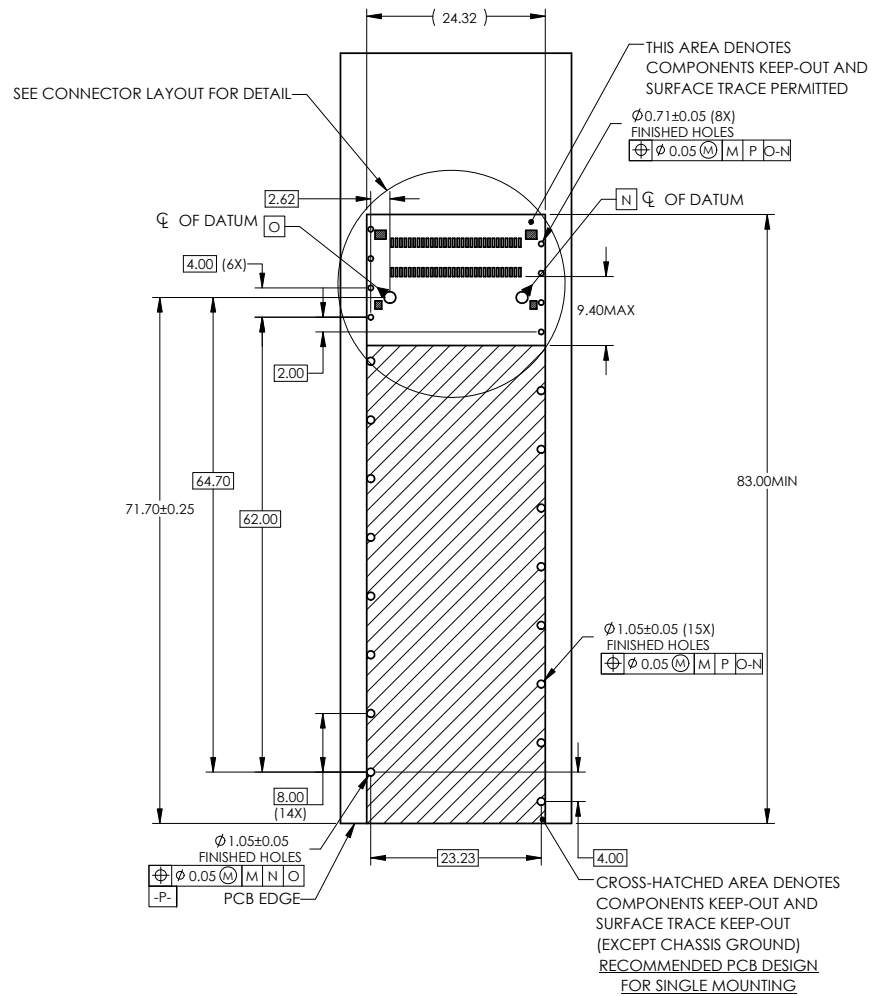
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REF.	E APPD		SIZE A4	DWG. NO. P-UE62-B1620-021E1	REV. C
CODE IDENT. NO. 03554	DWG APPD J.SI	JUL 04,19	SCALE 1:1	PROJECT UE62	SHEET 4 OF 6

8 7 6 5 4 3 2 1

REVISIONS				
REV.	ECN	DESCRIPTION	DATE	APPROVED
A		PROPOSAL	JUL 04,19	J.SI
B		UPDATE THE NOTES ON PAGE4	JUL 31,19	J.SI
C		UPDATE THE PCB DIMENSION	AUG 20,19	J.SI

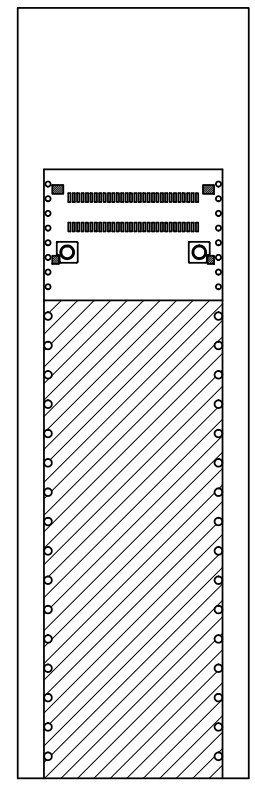
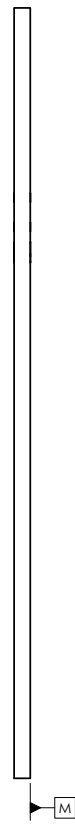
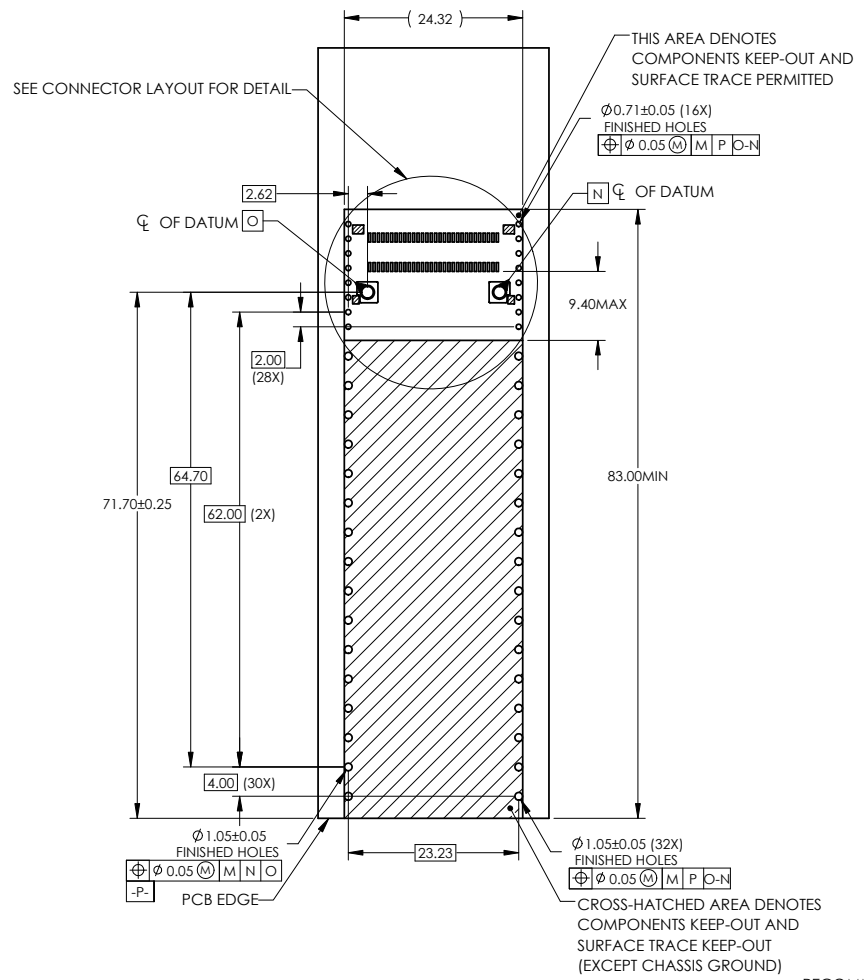


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	DRAWN Mike. H	JUL 04,19	TITLE		
	DESIGNED		1X1 OSFP CAGE ASSEMBLY EMI ENHANCEMENT		
	CHECKED Chigow.X	JUL 04,19	SIZE A4	DWG. NO. P-UE62-B1620-021E1	REV. C
	QA APPD		SCALE 1:1	PROJECT UE62	SHEET 5 OF 6

REVISIONS				
REV.	ECN	DESCRIPTION	DATE	APPROVED
A		PROPOSAL	JUL 04,19	J.SI
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RECOMMENDED PCB DESIGN FOR BELLY TO BELLY MOUNTING

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	DRAWN: Mike. H DESIGNED: CHECKED: Chigow.X QA APPD:	JUL 04,19	JUL 04,19	TITLE: 1X1 OSFP CAGE ASSEMBLY EMI ENHANCEMENT	
	E APPD:		SIZE: A4	DWG. NO.: P-UE62-B1620-021E1	REV. C
	DWG APPD: J.SI	JUL 04,19	SCALE: 1:1	PROJECT: UE62	SHEET: 6 OF 6